GQM Series Specifications and Test Methods (1)

No.	o. Item		Specifications	Test Method				
1	1 Operating Temperature		-55 to 125°C	Reference Temperature: 25℃				
2	P. Rated Voltage		See the previous page.	The rated voltage is defined as the maximum voltage which may be applied continuously to the capacitor. When AC voltage is superimposed on DC voltage, V ^{p-p} or V ^{o-p} , whichever is larger, should be maintained within the rated voltage range.				
3	Appearar	nce	No defects or abnormalities	Visual inspection				
4	Dimensio	n	Within the specified dimensions	Using calipers				
5	Dielectric Strength		No defects or abnormalities	No failure should be observed when 300%* of the rated voltage is applied between the terminations for 1 to 5 seconds, provided the charge/discharge current is less than 50mA. *250V only 250%				
6	Insulation Resistance		More than $10,000M\Omega$ (Whichever is smaller)	The insulation resistance should be measured with a DC voltage not exceeding the rated voltage at 25℃ and 75%RH max. and within 2 minutes of charging.				
7	Capacitance		Within the specified tolerance	The capacitance/Q should be measured at 25°C at the				
			30pF min.: Q≥1400	frequency and voltage shown in the table.				
8	Q		30pF max.: Q≥800+20C	Frequency		1±0.1MHz		
			C: Nominal Capacitance (pF)	Voltage		0.5 to 5Vrms	<u> </u>	
		Capacitance Change	Within the specified tolerance (Table A)	The temperature co	he capacitance			
		Temperature Coefficient	Within the specified tolerance (Table A)	When cycling the te the capacitance sho temperature coeffici	erance for the			
9	Capacitance Temperature Characteristics	Capacitance Drift	Within ±0.2% or ±0.05pF (Whichever is larger)	The capacitance dribetween the maxim	rift is calculated by dividing the differences num and minimum measured values in the the capacitance value in step 3. Temperature (°C) Reference Temp. ±2 -55±3 Reference Temp. ±2 125±3 Reference Temp. ±2			
			No removal of the terminations or other defect should occur.	Solder the capacitor	to the test jig	(glass epoxy bo	ard) shown in	
10		esive Strength ermination		Fig. 1 using a eutectic solder. Then apply 10N* force in parallel with the test jig for 10±1 sec. The soldering should be done either with an iron or using the reflow method and should be conducted with care so that the soldering is uniform and free of defects such as heat shock. *5N (GQM188)				
				GQM18	1.0	3.0	1.2	
			Solder resist	GQM21	1.2	4.0	1.65	
			Baked electrode or copper foil		Fig.	1	(in mm)	
		Appearance	No defects or abnormalities	Solder the capacitor to the test jig (glass epoxy board) in the				
11	Vibration Resistance	Capacitance	Within the specified tolerance 30pF min.: Q≥1400 30pF max.: Q≥800+20C C: Nominal Capacitance (pF)	same manner and under the same conditions as (10). The capacitor should be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, should be traversed in approximately 1 minute. This motion should be applied for a period of 2 hours in each of				
			4 /	3 mutually perpend		•		

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GQM Series Specifications and Test Methods (1)

Dielectric

Strength

Appearance

Capacitance

Change

Q

I.R.

Humidity

Steady

State

16

No failure

No marking defects
Within ±5% or ±0.5pF

(Whichever is larger)

10pF max.: Q≥200+10C C: Nominal Capacitance (pF)

30pF min.: Q≥350

More than 1,000M $\!\Omega$

The measured and observed characteristics should satisfy the

specifications in the following table.

10pF and over, 30pF and below: Q≧275+5C/2

No.	Ite	em	Specifications			Test Method					
12	Deflection		No crack or marked defect should occur.		Solder the capacitor on the test jig (glass epoxy board) shown in Fig. 2 using a eutectic solder. Then apply a force in the direction shown in Fig. 3. The soldering should be done by the reflow method and should be conducted with care so that the soldering is uniform and free of defects such as heat shock. 20 50 Pressurizing speed: 1.0mm/sec. Pressurize						
			\$4.5								
										Typo	100
						Type GQM18	1.0	3.0	1.2		
			GQM21	1.2	4.0	1.65		Capacitar 45	nce meter 45		
						(in mm)	- 				
				Fig. 2				Fig.	3		
13	3 Solderability of Termination		75% of the terminations are to be soldered evenly and continuously.		Immerse the capacitor in a solution of ethanol (JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight proportion). Preheat at 80 to 120°C for 10 to 30 seconds. After preheating, immerse in eutectic solder solution for 2±0.5 seconds at 230±5°C or Sn-3.0Ag-0.5Cu solder solution for 2±0.5 seconds at 245±5°C						
			The measured and specifications in the			nould satisfy the					
		Appearance	No marking defects	3							
	Resistance to Soldering Heat	Capacitance Change	Within ±2.5% or ± (Whichever is large	•			Preheat the capacitor at 120 to 150°C for 1 minute. Immerse the				
14		Q	30pF min.: Q≥1400 30pF max.: Q≥800+20C		capacitor in a eutectic solder or Sn-3.0Ag-0.5Cu solder solution at 270±5℃ for 10±0.5 seconds. Let sit at room temperature for 24±2 hours.						
			C: Nominal Capaci	tance (pF)							
		I.R.	More than 10,000M	ΙΩ							
		Dielectric Strength	No failure								
			The measured and observed characteristics should satisfy the specifications in the following table.								
		Appearance	No marking defects		Fix the capacitor to the supporting jig in the same manner and under the same conditions as (10). Perform the five cycles according to the four heat treatments listed in the following table.						
15	Temperature Cycle	Capacitance Change	Within ±2.5% or ±0.25pF (Whichever is larger)								
		Q	30pF min.: Q≧1400)						rature, then me	asure.
			30pF max.: Q≧800	+20C			Step	1	2	3	4
			C: Nominal Capaci	tance (pF)			Temp. (°C)	Min. Operating Temp. +0/-3	Temp.	Max. Operating Temp. +3/-0	Room Temp.
		I.R.	More than 10,000N	1Ω			Time (min.)	30±3	2 to 3	30±3	2 to 3

Let the capacitor sit at 40±2°C and 90 to 95% humidity for 500±12 hours.

Remove and let sit for 24 ± 2 hours (temperature compensating type) at room temperature, then measure.

Continued on the following page.



GQM Series Specifications and Test Methods (1)

Ontinued from the preceding page.

No.	. Item		Specifications	Test Method		
17			The measured and observed characteristics should satisfy the specifications in the following table.			
	Humidity Load	Appearance	No marking defects			
		Capacitance Change	Within ±7.5% or ±0.75pF (Whichever is larger)	Apply the rated voltage at 40 ± 2 °C and 90 to 95% humidity for 500±12 hours. Remove and let sit for 24±2 hours at room		
		Q	30pF min.: Q≥200 30pF max.: Q≥100+10C/3	temperature then measure. The charge/discharge current is less than 50mA.		
			C: Nominal Capacitance (pF)			
		I.R.	More than 500MΩ			
18		The measured and observed characteristics should satis specifications in the following table.				
	High Temperature Load	Appearance	No marking defects			
		Capacitance Change	Within ±3% or ±0.3pF (Whichever is larger)	Apply 200% of the rated voltage for 1000±12 hours at the maximum operating temperature ±3℃.		
		Q	30pF min.: Q≧350 10pF and over, 30pF and below: Q≥275+5C/2 10pF max.: Q≥200+10C	Let sit for 24±2 hours (temperature compensating type) at room temperature, then measure. The charge/discharge current is less than 50mA.		
			C: Nominal Capacitance (pF)			
		I.R.	More than 1,000M Ω			

Table A

	Nominal Values (ppm/°C) *1	Capacitance Change from 25°C (%)						
Char.		–55°C		-30℃		−10°C		
		Max.	Min.	Max.	Min.	Max.	Min.	
5C	0±30	0.58	-0.24	0.40	-0.17	0.25	-0.11	

^{*1:} Nominal values denote the temperature coefficient within a range of 25 to 125°C.